Illustration of Non-Concurrent Supply of Impurities & Concurrent Supply of Impurities Attachment:

Non-concurrent supply of Mg and Si = Molecular doping is possible

FIG. A: Technique according to the present invention

1. Ga and Mg are supplied (Ga atom layer is in several layers, Mg is in doping level).

Mg

S

S

S

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Ga

GaN

Mg atoms are deposited in Ga atoms under a condition that positions thereof are fixed (The positions of Mg atoms are settled).

- 2. When Si is scattered, Si repels Ga, so that Mg and Si are arrayed side-by-side.
- and SI are arrayed side-by-side.

 3. NH₃ is flowed on the resulting layers to nitride them, whereby semiconductor crystallization is effected.

Doped with Mg and Si side-by-side.

FIG. B: Technique according to Kobayashi

- Ga is deposited (Ga atom layer is in several layers).
- Si is supplied concurrently with Mg.Si and Mg are not arrayed side-by-side,but they are situated discretely.
- $\overline{\bf 3.}$ NH $_3$ is flowed on the resulting layers to nitride them, whereby semiconductor crystallization is effected.

Doped with Mg and Si discretely.

